

## **Description**

#### **Application Features** ● 450V, 13A $R_{DS(ON)}$ < 0.47 $\Omega$ @ $V_{GS}$ = 10V

- Fast Switching
- Improved dv/dt Capability
- Low on-resistance

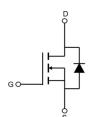
Load Switch

- PWM Application
- Power management

100% UIS 100% ΔVds







Schematic Diagram

## **Package Marking and Ordering Information**

Device Marking	Device	OUTLINE	Device Package	Reel Size	Reel (PCS)	Per Carton (PCS)
VSM13N45-T2	VSM13N45	TAPING	TO-252	13inch	2500	25000

# **Absolute Maximum Ratings** (Tc=25℃ unless otherwise specified)

Symbol	Parameter		Max.	Units
$V_{DSS}$	Drain-Source Voltage		450	V
V <sub>GSS</sub>	Gate-Source Voltage		±30	V
I <sub>D</sub>	Continuous Drain Current	T <sub>C</sub> = 25°C	13	Α
		T <sub>C</sub> = 100℃	8.5	Α
I <sub>DM</sub>	Pulsed Drain Current note1		52	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy note2		218	mJ
$P_D$	Power Dissipation	T <sub>C</sub> = 25°C	140	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		0.89	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		75	°C/W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	$^{\circ}\!\mathbb{C}$



# **Electrical Characteristics** (T<sub>J</sub>=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units		
Off Characteristic								
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	450	-	-	V		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =450V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C	-	-	1	μA		
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> = ±30V	-	-	±100	nA		
On Characteristics								
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2	3	4	V		
R <sub>DS(on)</sub>	Static Drain-Source on-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =6.5A	-	0.4	0.47	Ω		
Dynamic Characteristics								
C <sub>iss</sub>	Input Capacitance	\\ -05\\\\ -0\\	-	1535	-	pF		
Coss	Output Capacitance	$V_{DS}$ =25V, $V_{GS}$ =0V,	-	147	-	pF		
C <sub>rss</sub>	Reverse Transfer Capacitance	f=1.0MHz	-	9.6	-	pF		
Qg	Total Gate Charge	\/ -200\/ I -12A	-	28	-	nC		
$Q_{gs}$	Gate-Source Charge	V <sub>DD</sub> =200V, I <sub>D</sub> =13A, V <sub>GS</sub> =10V	-	7	-	nC		
$Q_gd$	Gate-Drain("Miller") Charge	VGS-10V	-	11	-	nC		
Switching	Characteristics							
t <sub>d(on)</sub>	Turn-on Delay Time		-	14	-	ns		
t <sub>r</sub>	Turn-on Rise Time	V <sub>DD</sub> =200V, I <sub>D</sub> =13A,	-	25	-	ns		
t <sub>d(off)</sub>	Turn-off Delay Time	R <sub>G</sub> =12Ω	-	44	-	ns		
t <sub>f</sub>	Turn-off Fall Time		-	28	-	ns		
Drain-Source Diode Characteristics and Maximum Ratings								
Is	Maximum Continuous Drain to Source Diode Forward Current			-	13	Α		
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current			-	52	Α		
$V_{SD}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>SD</sub> =13A	-	-	1.4	V		
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> =0V, I <sub>S</sub> =13A,	-	303	-	ns		
Q <sub>rr</sub>	Reverse Recovery Charge	di/dt=100A/µs	-	1.8	-	μC		

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

- 2. EAS condition:  $T_J$  = 25°C,  $V_{DD}$  = 50V,  $V_G$  = 10V, L= 10mH,  $I_{AS}$  = 6.6A
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤1%



# **Typical Performance Characteristics**

Figure1: Output Characteristics

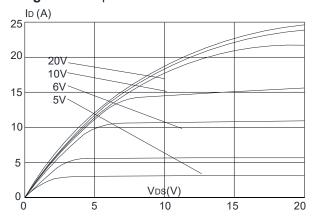


Figure 3:On-resistance vs. Drain Current

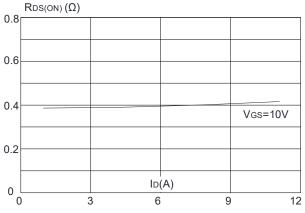


Figure 5: Gate Charge Characteristics

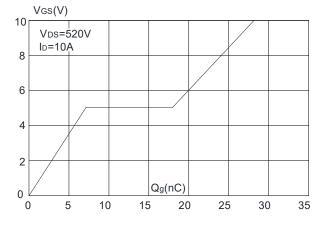


Figure 2: Typical Transfer Characteristics

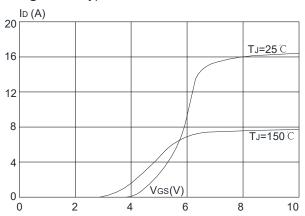


Figure 4: Body Diode Characteristics

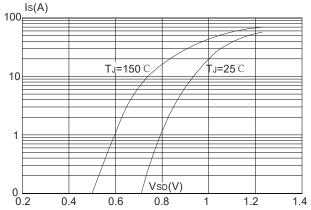
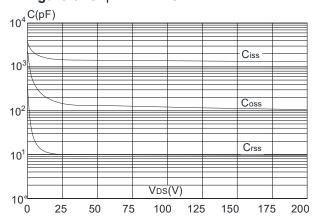


Figure 6: Capacitance Characteristics





**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature

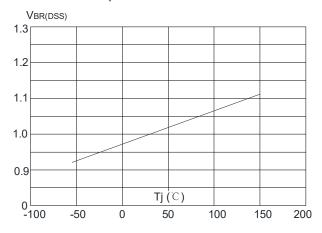
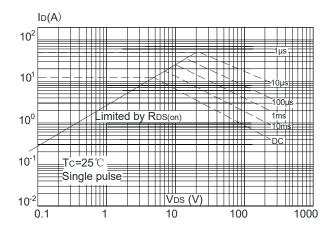
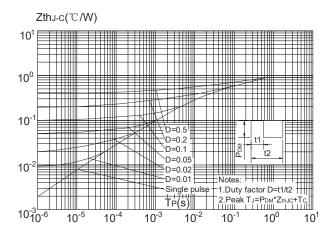


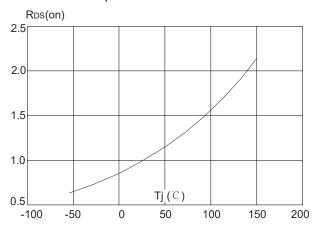
Figure 9: Maximum Safe Operating Area



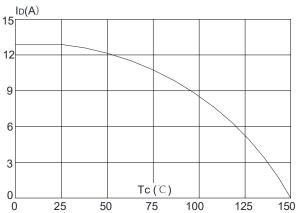
**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Case



**Figure 8:** Normalized on Resistance vs. Junction Temperature



**Figure 10:** Maximum Continuous Drain Current vs. Case Temperature





## **Test Circuit**

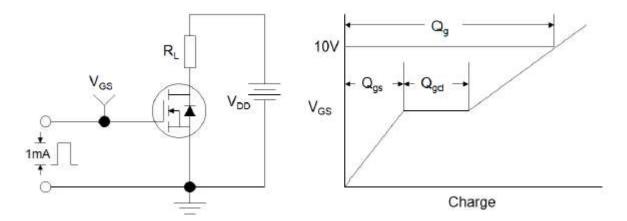


Figure1:Gate Charge Test Circuit & Waveform

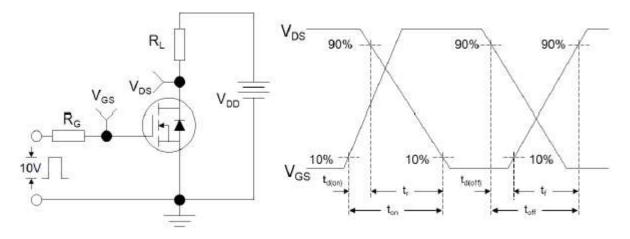


Figure 2: Resistive Switching Test Circuit & Waveforms

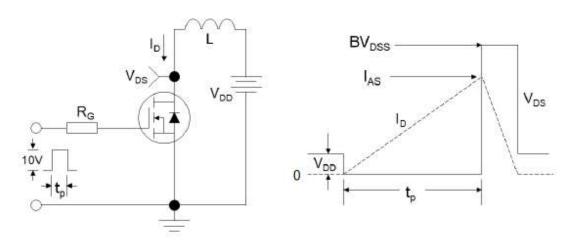


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms